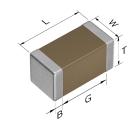
积层贴片陶瓷片式电容器

C1608X6S1C335M080AC

RoHS Reach Halogen Free Pb Free

交货型号	C1608X6S1C335MT****
用途	一般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	▲ 量产体制(新设计非推荐)



	尺寸
长度(L)	1.60mm ±0.20mm
宽度(W)	0.80mm ±0.20mm
厚度(T)	0.80mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)
J世代/年益/41/10 (LA/	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)
1世仔/坪益41/四 (FD)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)
3世代/平鉱作/四 (t U)	0.60mm to 0.80mm(Reflow Soldering)

······································	气特性
电容	$3.3\mu\mathrm{F}~\pm20\%$
额定电压	16VDC
温度特性	$X6S(\pm 22\%)$
耗散因数(Max.)	10%
绝缘电阻 (Min.)	30ΜΩ

	其他	
焊接方法	流体	
坪 接刀法	回流	
AEC-Q200	NO NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



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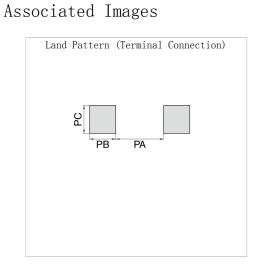
特性图表(这是参考数据,并不保证产品的特性。)

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